

View Online at <https://aerobasegroup.com/nsn/8040-01-151-5439>

Physical Form:

Paste

Specific Usage Design:

For solder pad encapsulation or sealing the head disc area in floppy disk assemblies

Special Features:

Premixed and degassed; ship and store frozen

Material:

Plastic epoxy

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

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